

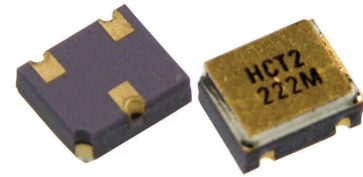
# Surface Mount NPN General Purpose Transistor

## 2N2222AUB (TX, TXV)



### Features:

- Ceramic 3 pin surface mount package (UBN)
- Miniature package to minimize circuit board area
- Hermetically sealed
- Processed per MIL-PRF-19500/255
- Same footprint and pin-out as many SOT-23 package transistors



### Description:

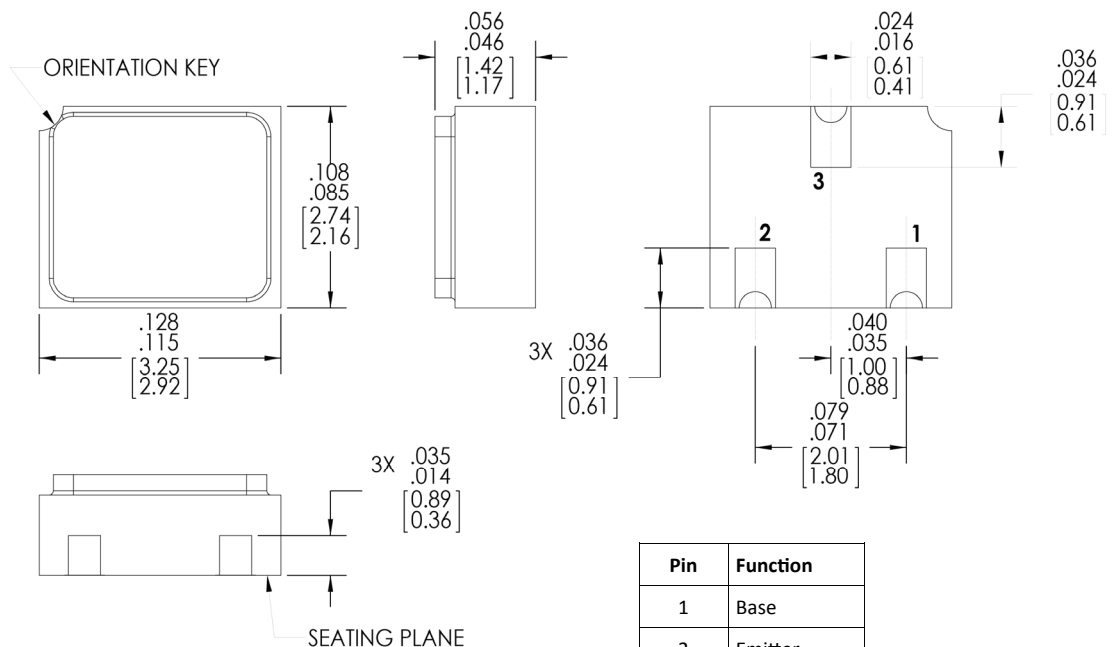
The 2N2222AUB (TX, TXV) is a miniature hermetically sealed ceramic surface mount general purpose switching transistor. The miniature three pin ceramic package is ideal for upgrading commercial grade circuits to military reliability levels where plastic SOT-23 devices have been used. The "UB" suffix denotes the 3 terminal chip carrier package.

Typical screening per MIL-PRF-19500/255. The burn-in condition is  $V_{CB} = 30\text{ V}$ ,  $P_D = 200\text{ mW}$ ,  $T_A = 25^\circ\text{C}$ ,  $t = 80\text{ hrs}$ . Refer to MIL-PRF-19500/255 for complete requirements. In addition, the TX and TXV versions receive 100% thermal response testing.

When ordering parts without processing, do not use the TX or TXV suffix.

### Applications:

- General switching
- Amplification
- Signal processing
- Radio transmission
- Logic gates



#### General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

OPTEK Technology, Inc.  
1645 Wallace Drive, Carrollton, TX 75006 | Ph: +1 972 323 2200  
[www.optekinc.com](http://www.optekinc.com) | [www.ttelectronics.com](http://www.ttelectronics.com)

# Surface Mount NPN General Purpose Transistor

## 2N2222AUB (TX, TXV)



### Electrical Specifications

#### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

|                                                           |                                             |
|-----------------------------------------------------------|---------------------------------------------|
| Collector-Base Voltage                                    | 75V                                         |
| Collector-Emitter Voltage                                 | 50V                                         |
| Emitter-Base Voltage                                      | 6.0V                                        |
| Collector Current-Continuous                              | 800mA                                       |
| Operating Junction Temperature ( $T_J$ )                  | $-65^\circ\text{C}$ to $+200^\circ\text{C}$ |
| Storage Junction Temperature ( $T_{stg}$ )                | $-65^\circ\text{C}$ to $+200^\circ\text{C}$ |
| Power Dissipation @ $T_A = 25^\circ\text{C}$              | 0.3 W                                       |
| Power Dissipation @ $T_c = 25^\circ\text{C}$              | 1.00 W <sup>(1)</sup>                       |
| Soldering Temperature (vapor phase reflow for 30 seconds) | 215° C                                      |
| Soldering Temperature (heated collet for 5 seconds)       | 260° C                                      |

#### Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| SYMBOL                     | PARAMETER                           | MIN | MAX | UNITS         | TEST CONDITIONS                                                           |
|----------------------------|-------------------------------------|-----|-----|---------------|---------------------------------------------------------------------------|
| <b>OFF CHARACTERISTICS</b> |                                     |     |     |               |                                                                           |
| $V_{(BR)CBO}$              | Collector-Base Breakdown Voltage    | 75  |     | V             | $I_C = 10\text{ }\mu\text{A}$ , $I_E = 0$                                 |
| $V_{(BR)CEO}$              | Collector-Emitter Breakdown Voltage | 50  |     | V             | $I_C = 10\text{ mA}$ , $I_B = 0$                                          |
| $V_{(BR)EBO}$              | Emitter-Base Breakdown Voltage      | 6.0 |     | V             | $I_E = 10\text{ }\mu\text{A}$ , $I_C = 0$                                 |
| $I_{CBO}$                  | Collector-Base Cutoff Current       |     | 10  | nA            | $V_{CB} = 60\text{ V}$ , $I_E = 0$                                        |
|                            |                                     |     | 10  | $\mu\text{A}$ | $V_{CB} = 60\text{ V}$ , $I_E = 0$ , $T_A = 150^\circ\text{C}$            |
| $I_{EBO}$                  | Emitter-Base Cutoff Current         |     | 10  | nA            | $V_{EB} = 4\text{ V}$ , $I_C = 0$                                         |
| $I_{CES}$                  | Collector Emitter Cutoff Current    |     | 50  | nA            | $V_{CE} = 50\text{ V}$                                                    |
| <b>ON CHARACTERISTICS</b>  |                                     |     |     |               |                                                                           |
| $h_{FE}$                   | Forward-Current Transfer Ratio      | 50  |     | -             | $V_{CE} = 10\text{ V}$ , $I_C = 0.1\text{ mA}$                            |
|                            |                                     | 75  | 325 | -             | $V_{CE} = 10\text{ V}$ , $I_C = 1.0\text{ mA}$                            |
|                            |                                     | 100 |     | -             | $V_{CE} = 10\text{ V}$ , $I_C = 10\text{ mA}$                             |
|                            |                                     | 100 | 300 | -             | $V_{CE} = 10\text{ V}$ , $I_C = 150\text{ mA}$ <sup>(2)</sup>             |
|                            |                                     | 30  |     | -             | $V_{CE} = 10\text{ V}$ , $I_C = 500\text{ mA}$ <sup>(2)</sup>             |
|                            |                                     | 35  |     | -             | $V_{CE} = 10\text{ V}$ , $I_C = 10\text{ mA}$ , $T_A = -55^\circ\text{C}$ |

Note:

1. Derate linearly 6.6 mW/°C above 25° C

2. Pulse Width  $\leq 300\text{ }\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

#### General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

OPTEK Technology, Inc.  
1645 Wallace Drive, Carrollton, TX 75006 | Ph: +1 972 323 2200  
www.optekinc.com | www.ttelectronics.com

# Surface Mount NPN General Purpose Transistor

2N2222AUB (TX, TXV)



## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| SYMBOL                       | PARAMETER                                   | MIN | MAX | UNITS | TEST CONDITIONS                                                                            |
|------------------------------|---------------------------------------------|-----|-----|-------|--------------------------------------------------------------------------------------------|
| ON CHARACTERISTICS           |                                             |     |     |       |                                                                                            |
| V <sub>CE (SAT)</sub>        | Collector-Emitter Saturation Voltage        |     | 0.3 | V     | I <sub>C</sub> = 150 mA, I <sub>B</sub> = 15 mA <sup>(2)</sup>                             |
|                              |                                             |     | 1.0 | V     | I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA <sup>(2)</sup>                             |
| V <sub>BE(SAT)</sub>         | Base-Emitter Saturation Voltage             | 0.6 | 1.2 | V     | I <sub>C</sub> = 150 mA, I <sub>B</sub> = 15 mA <sup>(2)</sup>                             |
|                              |                                             |     | 2.0 | V     | I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA <sup>(2)</sup>                             |
| SMALL-SIGNAL CHARACTERISTICS |                                             |     |     |       |                                                                                            |
| h <sub>fe</sub>              | Small Signal Forward Current Transfer Ratio | 50  |     | -     | V <sub>CE</sub> = 10 V, I <sub>C</sub> = 1.0 mA, f = 1.0 kHz                               |
| Ih <sub>fe</sub>             | Small Signal Forward Current Transfer Ratio | 2.5 |     | -     | V <sub>CE</sub> = 20 V, I <sub>C</sub> = 20 mA, f = 100 MHz                                |
| C <sub>obo</sub>             | Open Circuit Output Capacitance             |     | 8.0 | pF    | V <sub>CB</sub> = 10 V, 100 kHz ≤ f ≤ 1.0 MHZ                                              |
| C <sub>ibo</sub>             | Input Capacitance (Output Open)             |     | 25  | pF    | V <sub>EB</sub> = 0.5 V, 100 kHz ≤ f ≤ 1.0 MHZ                                             |
| SWITCHING CHARACTERISTICS    |                                             |     |     |       |                                                                                            |
| t <sub>on</sub>              | Turn-On Time                                |     | 35  | ns    | V <sub>CC</sub> = 30 V, I <sub>C</sub> = 150 mA, I <sub>B1</sub> = 15 mA                   |
| t <sub>off</sub>             | Turn-Off Time                               |     | 300 | ns    | V <sub>CC</sub> = 30 V, I <sub>C</sub> = 150 mA, I <sub>B1</sub> = I <sub>B2</sub> = 15 mA |

General Note  
TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

OPTEK Technology, Inc.  
1645 Wallace Drive, Carrollton, TX 75006 | Ph: +1 972 323 2200  
[www.optekinc.com](http://www.optekinc.com) | [www.ttelectronics.com](http://www.ttelectronics.com)

## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9